# **RFUV1703**

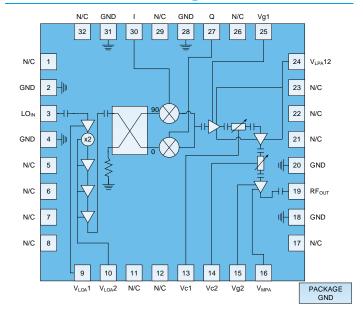
## 21 GHz to 26.5 GHz GaAs MMIC IQ Upconverter

## **General Description**

Qorvo's RFUV1703 is a 21 GHz to 26.5 GHz GaAs pHEMT upconverter, incorporating an integrated doubler, LO buffer amplifier, a balanced single sideband (image rejection) mixer followed by Variable Gain Amplifier, DC decoupling capacitors. The combination of high performance part and low-cost packaging makes the RFUV1703 a cost effective solution, ideally suited to both current and next generation point-to-point and  $V_{\text{SAT}}$  applications. RFUV1703 is packaged in a 5 mm x 5 mm QFN to simplify both system level board design and volume assembly.

Lead-free and RoHS compliant

## **Functional Block Diagram**





Package: QFN, 32 Pin, 5 mm x 5 mm x 0.95 mm

#### **Product Features**

• RF Frequency: 21 GHz to 26.5 GHz

LO Frequency (LSB): 10.5 GHz to 15.2 GHz
LO Frequency (USB): 8.5 GHz to 13.25 GHz

IF Frequency: DC to 4 GHz
Conversion Gain (Max): 21 dB
Conversion Gain (Min): -10 dB

NF (Max. Gain): 12 dB
OIP3 (Max. Gain): +27 dBm
Image Rejection: 15 dBc

Performance is typical across frequency. Please reference electrical specification table and data plots for more details.

## **Applications**

- Point-to-Point
- Vsat

## **Ordering Information**

Part	Description
RFUV1703S2	2-Piece Sample Bag
RFUV1703SB	5-Piece Bag
RFUV1703SQ	25-Piece Bag
RFUV1703SR	100 Pieces on 7" reel
RFUV1703TR7	750 Pieces on 7" reel
RFUV1703PCBA-410	Evaluation Board



# **Absolute Maximum Ratings**

Parameter	Rating	Unit
LPA Drain Voltage V <sub>D</sub>	6	V
LOA Drain Voltage	6	V
IF Input Power	15	dBm
LO Input Power	15	dBm
Storage Temperature	-65 to +150	°C

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

## **Nominal Operating Parameters**

Doromotor	;	Specification		Units	Condition	
Parameter	Min	Typical	Max	Units	Condition	
RF Frequency	21		26.5	GHz		
LO Frequency: LSB	10.5		15.25	GHz		
LO Frequency: USB	8.5		13.25	GHz		
IF Frequency	DC	2.5	4.0	GHz		
LO input Drive		0		dBm		
Conversion Gain (Max.) (USB)	19	21		dB	LO = 9.95 GHz & 11.5 GHz	
Conversion Gain (Min.) (USB)	-5.5	-5		dB	LO = 9.95 GHz & 11.5 GHz	
OIP3 (Max. Gain) (USB)	23.5	29		dBm	LO = 9.95 GHz	
OIP3 (-5 dB Gain) (USB)	0.5	6.5		dBm	LO = 9.95 GHz	
OIP3 (Max. Gain) (USB)	20.5	27		dBm	LO = 11.5 GHz	
OIP3 (-5 dB Gain) (USB)	4	9		dBm	LO = 11.5 GHz	
Image Rejection (Max. Gain) (USB)	15	20		dBc	LO = 9.95 GHz	
Image Rejection (Max. Gain) (USB)	14	20		dBc	LO = 11.5 GHz	
LO Leakage @ RF-Port (Max. Gain) (USB)		-10	5	dBm	LO = 9.95 GHz	
LO Leakage @ RF-Port (Max. Gain) (USB)		1	7.5	dBm	LO = 11.5 GHz	
NF (Max. Gain)		12		dB		
LO Return Loss		10		dB		
RF Return Loss		10		dB		
V <sub>LOA</sub>		4		V		
V <sub>LPA</sub>		3.5		V		
V <sub>MOA</sub>		4.5		V		
ILOA		205		mA		
I <sub>LOA1,2</sub>		120		mA		
Імра		120		mA		
ITOTAL		445		mA		
V <sub>C1</sub> , V <sub>C2</sub>	-4		0	V		
Operating Temperature	-55	25	85	°C		



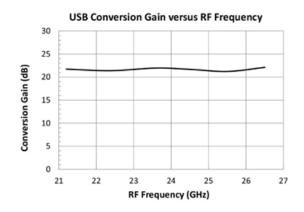
## **Performance Plots – USB Conversion**

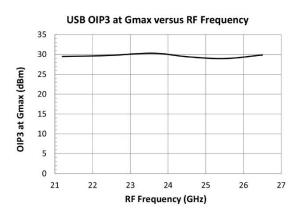
Measurements performed with I and Q (IF) ports connected to an external 90° Hybrid

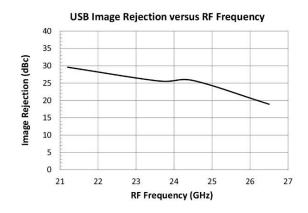
Test conditions unless otherwise noted: LO Power = 0 dBm and IF = 2.5 GHz, -10 dBm

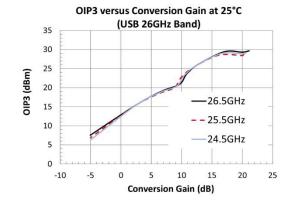
VLOA1 = VLOA2 = 4 V, ILOA1,2 = 205 mA; VLPA12 = 3.5 V, Adjust VG1 around -0.4 V to get ILPA12 = 120 mA

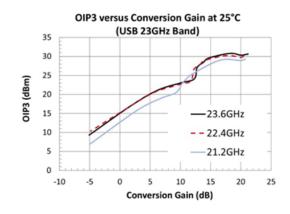
 $V_{MPA} = 4.5 \text{ V}$ , Adjust  $V_{G2}$  to get  $I_{MPA} = 120 \text{ mA}$ ,  $I_{TOTAL} = 445 \text{ mA}$ ,  $V_{C1} = V_{C2} = -4 \text{ V}$ 













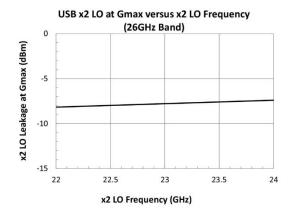
### Performance Plots – USB LO Leakage & Over Temperature

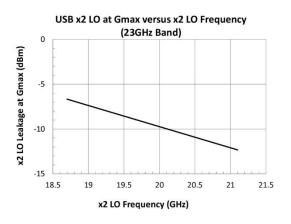
Measurements performed with I and Q (IF) ports connected to an external 90° Hybrid

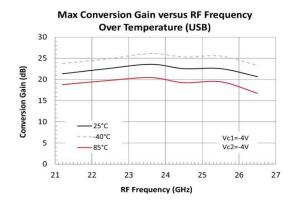
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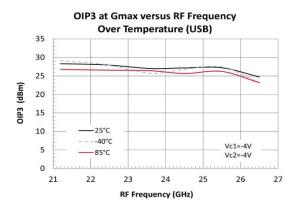
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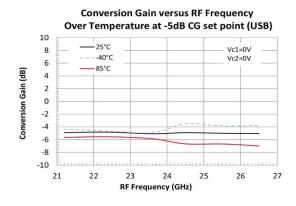
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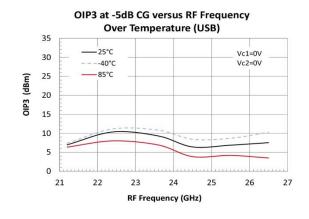














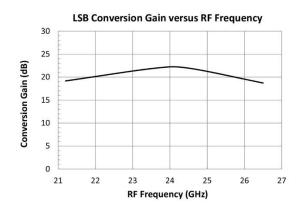
## Performance Plots - LSB Conversion & LO Leakage

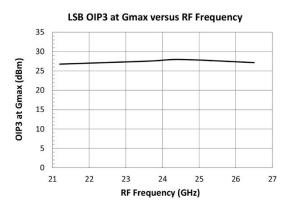
Measurements performed with I and Q (IF) ports connected to an external 90° Hybrid

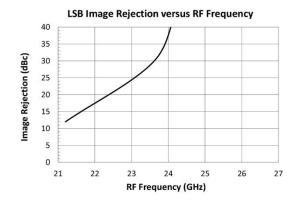
Test conditions unless otherwise noted: LO Power = 0 dBm and IF = 2.5 GHz, -10 dBm

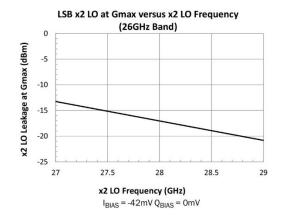
 $V_{LOA1} = V_{LOA2} = 4 \text{ V}, I_{LOA1,2} = 205 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ mA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ MA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ MA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ MA}; V_{LPA12} = 3.5 \text{ V}, Adjust V_{G1} \text{ around -0.4 V to get } I_{LPA12} = 120 \text{ MA}; V_{LPA12} = 3.5 \text{ V}; Adjust V_{G1} = 3.5 \text{ V}; Adj$ 

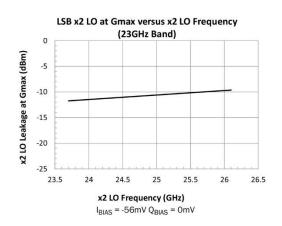
 $V_{MPA} = 4.5 \text{ V}$ , Adjust  $V_{G2}$  to get  $I_{MPA} = 120 \text{ mA}$ ,  $I_{TOTAL} = 445 \text{ mA}$ ,  $V_{C1} = V_{C2} = -4 \text{ V}$ 















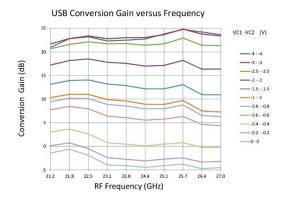
### Performance Plots - USB: Without IQ Bias

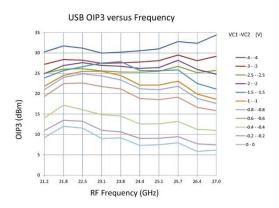
Measurements performed with I and Q (IF) ports connected to an external 90° Hybrid

Test conditions unless otherwise noted: LO Power = 0 dBm and IF = 2.5 GHz, -10 dBm

 $V_{MPA} = 4.5 \text{ V}, V_{LPA12} = 3.5 \text{ V}, V_{LOA1} = V_{LOA2} = 4 \text{ V}, I_{TOTAL} = 445 \text{ mA}, V_{G1} = V_{G2} = -0.4 \text{ V}$ 

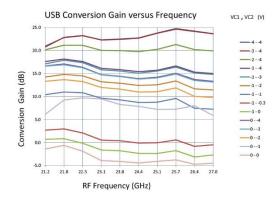
V<sub>C1</sub> and V<sub>C2</sub> are connected together off chip and changes over (-4 V to 0 V): Single Control Bias

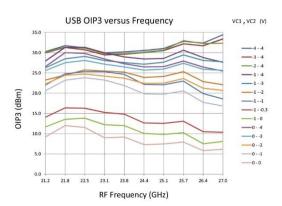




 $V_{MPA} = 4.5 \text{ V}, V_{LPA12} = 3.5 \text{ V}, V_{LOA1} = V_{LOA2} = 4 \text{ V}, I_{TOTAL} = 445 \text{ mA}, V_{G1} = V_{G2} = -0.4 \text{ V}$ 

V<sub>C1</sub> and V<sub>C2</sub> are separated controlled and changes over (-4 V to 0 V): Double Control Bias









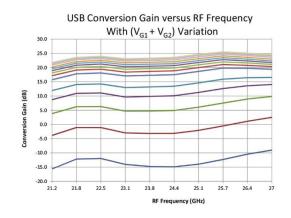
## Performance Plots - USB: Without IQ Bias (continued)

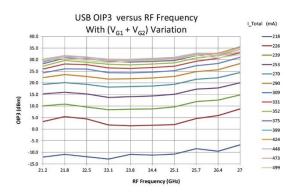
Measurements performed with I and Q (IF) ports connected to an external 90° Hybrid

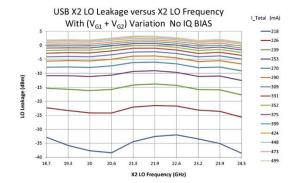
Test conditions unless otherwise noted: LO Power = 0 dBm and IF = 2.5 GHz, -10 dBm

 $V_{MPA} = 4.5 \text{ V}, V_{LPA12} = 3.5 \text{ V}, V_{LOA1} = V_{LOA2} = 4 \text{ V}, V_{C1} = V_{C2} = -4 \text{ V}$ 

V<sub>G1</sub> and V<sub>G2</sub> are connected together off chip and changes over (-0.3 V to -1 V): Single Control on V<sub>G1</sub> = V<sub>G2</sub>

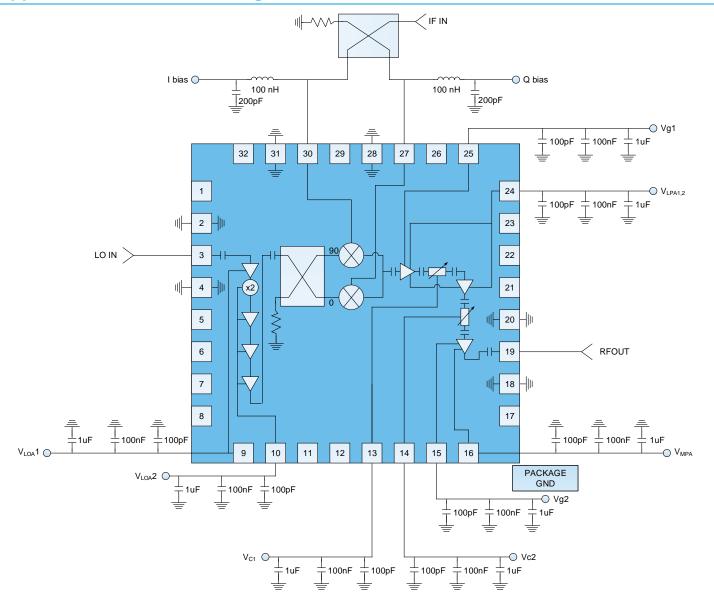








# **Application Circuit Block Diagram**



2\*LO - IF = RF (LSB), LO = 10.5 to 15.25 GHz

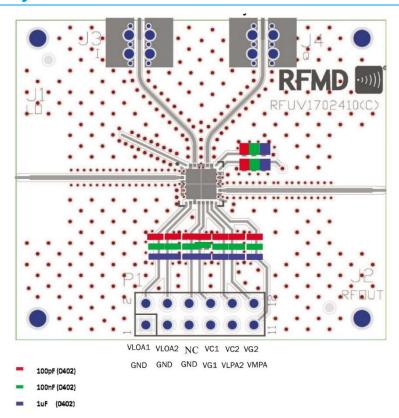
2\*LO + IF = RF (USB), LO = 8.5 GHz to 13.25 GHz

#### Notes:

- 1. External components for IQ biases are required.
- 2. External hybrid coupler is required.



## **Evaluation Board Layout**



# **Sub-Band Frequency Ranges**

Band	Frequency Range
23 GHz	21.2 GHz to 23.6 GHz
26 GHz	24.5 GHz to 26.5 GHz

# **Test Conditions and Bias Sequence**

Measurements performed with I and Q (IF) ports connected to an external  $90^{\circ}$  Hybrid, LO Power = 0 dBm and IF = 2.5 GHz, -10 dBm, unless otherwise stated.

 $V_{LOA1} = V_{LOA2} = 4 \text{ V}, \ I_{LOA1,2} = 205 \text{ mA}; \ V_{LPA12} = 3.5 \text{ V}, \ Adjust \ V_{G1} \ around \ -0.4 \text{ V} \ to \ get \ I_{LPA12} = 120 \text{ mA}; \ V_{LPA12} = 120 \text{ mA}; \ V_{LPA12}$ 

 $V_{MPA} = 4.5 \text{ V}, \text{ Adjust } V_{G2} \text{ to get } I_{MPA} = 120 \text{ mA}, \ I_{TOTAL} = 445 \text{ mA}, \ V_{C1} = V_{C2} = -4 \text{ V}.$ 

Typical Bias Sequence							
	G <sub>MAX</sub>						G <sub>MIN</sub>
V <sub>C1</sub> (V)	-4	-2	-1	0	0	0	0
V <sub>C2</sub> (V)	-4	-4	-4	-4	-2	-1	0

More dynamic range can be achieved using V<sub>G2</sub> over (-0.4 to -1 V) and V<sub>G1</sub> over (-0.4 to -1 V)



## 21 GHz to 26.5 GHz GaAs MMIC IQ Upconverter

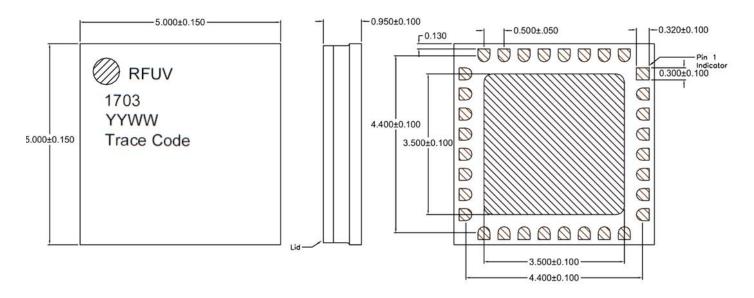
# **Pin Names and Description**

Pin Number	Label	Description
1	N/C	Not Connected
2	GND	Ground
3	LO	Local Oscillator Input. AC Coupled and Matched to 50 $\Omega$
4	GND	Ground
5	N/C	Not Connected
6	N/C	Not Connected
7	N/C	Not Connected
8	N/C	Not Connected
9	VLOA1	LOA Stage1 Drain Bias
10	VLOA2	LOA Stage2 Drain Bias
11	N/C	Not Connected
12	N/C	Not Connected
13	VC1	Control Line Number 1 (See Bias Sequence Description)
14	VC2	Control Line Number 2 (See Bias Sequence Description)
15	VG2	MPA Gate Bias
16	VMPA	MPA Drain Bias
17	N/C	Not Connected
18	GND	Ground
19	RFOUT	RF Output. AC Coupled and Matched to 50 Ω
20	GND	Ground
21	N/C	Not Connected
22	N/C	Not Connected
23	N/C	Not Connected
24	VLPA1, VLPA2	LPA Stage 1, 2 Drain Bias
25	VG1	LPA Stage 1, 2 Gate Bias
26	N/C	Not Connected
27	Q	IF Q Input
28	GND	Ground
29	N/C	Not Connected
30	I	IF I Input
31	GND	Ground
32	N/C	Not Connected





# **Package Marking and Dimensions**



All dimensions are in millimeters

Marking:

RFUV1703: Part number

YY: Part Assembly year WW: Part Assembly week



## **Assembly Notes**

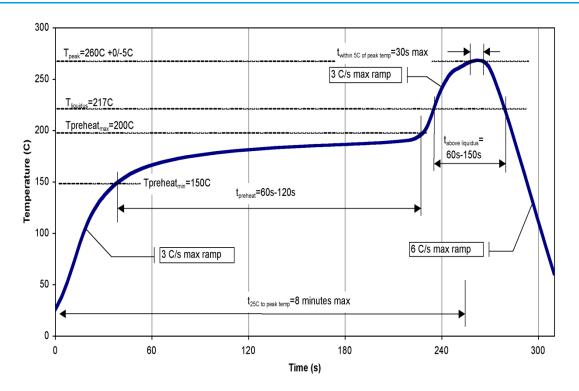
Compatible with lead-free soldering processes with 260°C peak reflow temperature.

This package is air-cavity and non-hermetic, and therefore cannot be subjected to aqueous washing. The use of no-clean solder to avoid washing after soldering is highly recommended.

Contact plating: Ni-Au.

Solder rework not recommended.

## **Recommended Soldering Profile**





### **Handling Precautions**

Parameter	Rating	Standard		
ESD – Human Body Model (HBM)	Class 1A	JESD22-A114		Caution! ESD-Sensitive Device
ESD-Charged Device Model (CDM)	Class C2	JESDE22-C101C		
MSL – Convection Reflow 260 °C	Level 2	JEDEC standard IPC/JEDEC J-STD-020		LOD COMORIVO DOVIGO

## **RoHS Compliance**

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- · Antimony Free
- TBBP-A (C<sub>15</sub>H<sub>12</sub>Br<sub>4</sub>O<sub>2</sub>) Free
- PFOS Free
- SVHC Free

#### **Contact Information**

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: <u>www.qorvo.com</u>
Tel: 1-844-890-8163

Email: customer.support@gorvo.com

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